



SPECIFICATION OF LCD MODULE

CUSTOMER 客户名称	
PART NO. 产品型号	OTM769 Y-YG-1-28
PRODUCTS TYPE 产品内容	
REMARKS 备注	
SIGNATURE BY CUST客户签署:	TOMER



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LCM System

1	LCD Type		
	S - STN	F - FSTN	D - DFSTN
2	Viewing Angle		
	D - Lower 6:00	U - Upper 12:00	O - Others
3	Display Mode Yellow Green positive	Blue negative	Grey positive
	FSTN positive	W - FSTN negative	
4	Polarizer Mode Reflective	Transflective	Transmissive
5	Connector Pin	Heat sealed	Zebra
6	Thickness of Glass		
	1.1mm	0.4mm	
	0.55mm	0.7mm	
7	Backlight Mode:		
	LED	CCFL	
8	Backlight Color Blue Red	☐ Amber☐ White	Yellow Green Without backlight
9	Temperature Grade		
	Normal temperature	Wide temperature	Super wide temperature
10	CG-ROM 01 for English + Japa	nese Language	Page: 2

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•REVISION RECORD

REV. NO.	REV. DATE	DESCRIPTION OF REVISION	PAGE	REMARK
1.0	01/03/08	INITIAL RELEASE	ALL	
1.1	11/21/07	Modify: OUTLINE DRAWING	15	
1.2	11/22/07	Add on 15 Package information	17	
1.3	12/08/07	1、Add on 4.2LED ABSOLUTE MAXIMUM RATINGS 2、Add on 4.2.2 LED POWER SOURCE	7	
		Add on 3.2 Environmental Absolute Maximum Rating	6	
	40/00/00	Add on 3.3 Electronic Static Discharge Maximum Rating	7	
1.4	10/09/08	3、 Modify:LED Quantity	9	
		4、Add on 13 QUALITY ASSURANCE	17	
		5、Add on STANDARD LCD MODULE NUMBERING SYSTEM	28	

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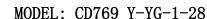
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1. FEATURES

Display mode STN(Y/G)

Display type Positive Transmissive

Backlight LED/(Y/G)4.2V

Controller SPLC780D-01 or Eequivalence

Driving voltage Single power

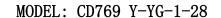
Connector PIN

2. MECHANICAL DATA

ITEM		WIDTH	HEIGHT	THICKNES S	UNIT
Mod	ule size	98.0	60.0	14.0(MAX)	mm
View	ring area	76.0	25.2	-	mm
	Construction		5*7		dots
character	Size	2.95	4.75	-	mm
	Pitch	3.55	5.35	1	mm
Dot	Size	0.55	0.55	-	mm
Dot	Pitch	0.60	0.60	-	mm
Diameter of mounting hole			Ф2.5		mm
W	/eight		About 90		g

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3. ABSOLUTE MAXIMUM RATINGS

3.1 Electrical Absolute Maximum Rating

(TA = 25, Vss=0V)

Item	Symbol	MIN.	Max.	Unit
Supply Voltage (Logic)	VDD-VSS	0	7.0	V
Supply Voltage (LCD Driveer)	V _{LCD}	VDD-12	VDD+0.3	٧
Input Voltage	V _{IN}	-0.3	VDD+0.3	V
Operating temperature	Тор	-20	70	°C
Storage temperature	Tsto	-30	80	°C

3.2 Environmental Absolute Maximum Rating

Item	Operating		Sto	rage	Comment	
itein	Min.	Max.	Min.	Max.	Comment	
Ambient temp	-20	+70	-30	+80	Note(1)	
Humidity	Not	e(2)	Note(2)		Without condensation	
Vibration		4.9M/S ²		19.6M/S2	XYZ direction	
Shock		29.4M/S ²		490M/S2	XYX direction	

Note(1) Ta=0°C: 50 Hr Max. Note(2) Ta≦40°C: 90%RH Max.

Ta≧40°C: Absolue humidity must be lower than the humidity of 90%RH@40°C

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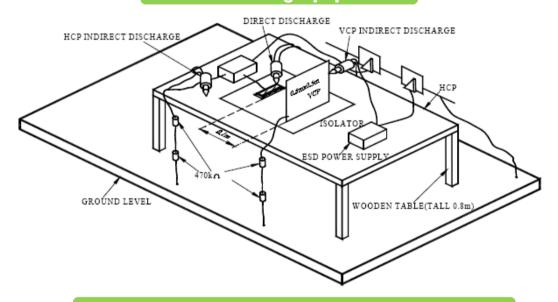


3.3 Electronic Static Discharge Maximum Rating

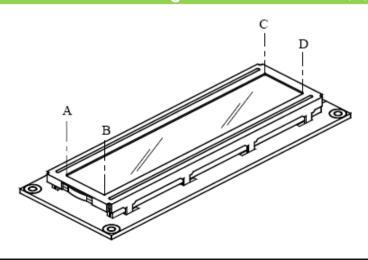
ESD Test Method: IEC-1000-4-2

Item	Description	Description			
Testing environment	Humidity: 30% t	Ambient temperature : 15℃ to 35℃ Humidity : 30% to 60% LCM(E.U.T) : Power up			
Testing equipment	Manufacture : No	Manufacture : Noiseken, Model No. ESD			
Testing condition	See drawing 1	See drawing 1			
Direct discharge	0 to \pm 6KV	Discharge point, see drawing2			
Indirect discharge	0 to ± 12KV	0 to ± 12KV Discharge point, see drawing1			
Pass condition		No malfunction of unit. Temporary malfunction of unit which can be recovered by system reset.			
Fail condition	Non. Recoverable	e malfunction of LCM or system.			

FIG1 ESD Testing Equipment



Direct Contact Discharge / Contact Point : A,B,C,D



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4. ELECTRICAL CHARACTERISTICS

(VDD = 4.5 to 5.5V, TA = 25)

Characteristic	Symbol	Condition	Min	Тур	Max	Unit
Operating Voltage	V _{DD}	-	4.5	-	5.5	V
Operating Current	I _{DD}	Internal oscillation or external clock (V _{DD} = 5.0V, fosc = 270kHz)	-	0.35	0.6	mA
Input Voltage (1)	V _{IH1}	-	2.2	-	V_{DD}	V
(except OSC1)	V _{IL1}	-	-0.3	-	0.6	V
Input Voltage (2)	V _{IH2}	-	V _{DD} -1.0	-	V _{DD}	V
(OSC1)	V _{IL2}	-	-0.2	-	1.0	V
Output Voltage (1)	V _{OH1}	I _{OH} = -0.205mA	2.4	-	-	V
(DB0 to DB7)	V _{OL1}	I _{OL} = 1.2mA	-	-	0.4	V
Output Voltage (2)	V _{OH2}	I _O = -40μA	0.9V _{DD}	-	-	V
(except DB0 to DB7)	V _{OL2}	I _O = 40μA	-	-	0.1V _{DD}	
V # 5	Vd _{COM}	I _O = ±0.1mA	-	-	1	
Voltage Drop	Vd _{SEG}	1 ₀ - ±0.1111A	-	-	1	V
Input Leakage Current	I _{LKG}	V_{IN} = 0V to V_{DD}	-1	-	1	
Input Low Current	I _{IL}	V_{IN} = 0V, V_{DD} = 5V (pull up)	-50	-125	-250	μΑ
Internal Clock (external Rf)	f _{OSC1}	Rf = $91k\Omega \pm 2\% (V_{DD} = 5V)$	190	270	350	kHz
	f _{OSC}		125	270	350	kHz
External Clock	duty	-	45	50	55	%
	t_R , t_F		-	-	0.2	μΑ
LCD Driving Voltage	V _{LCD}	V _{DD} -V5 (1/5, 1/4 bias)	3.0	-	13.0	V

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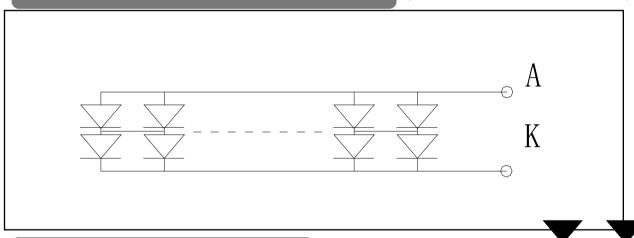
4.1 LED ELECTRICAL/OPTLCAL CHARACTERISTICS

Item	Symbol	min	typ	max	Unit	Condition
Forward Voltage	Vf	4. 0	4. 2	4. 4	V	If= 240 mA
Reverse Current	Ir	_	_	180	uА	Vr=5V
Dominant wave length	λр	568	570	574	nm	If= 240 mA
Spectral Line Half width	Δλ	-	30	_	nm	If=240mA
Luminance	Lv	-	190	-	cd/m²	If= 240 mA

4.2LED ABSOLUTE MAXIMUM RATINGS

Item	Symbol	Condition	Rating	Unit
Reverse Voltage	Vr	Ta=25 ℃	5	V
Absolute maximum forward current	Ifm	Ta=25 ℃	480	mA
Power description	pd	Ta=25 ℃	2400	mW

4.2.1 LED ARRAY BLOCK DIAGRAM (LED DICE 2×24= 48 dices)

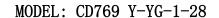


4.2.2 LED POWER SOURCE

LED	Option	Option Power source		
	А	15A/16K	R9、R11-R13	
	В	15K/16A	R8、R10、R12、R13	
	С	VDD/VSS	R9、R11-R15	
GND	FRM	R16		

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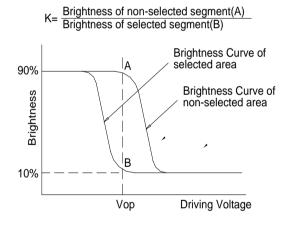




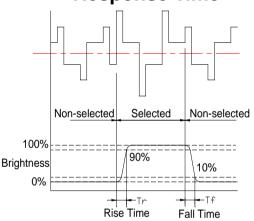
5. ELECTRO-OPTICAL CHARACTERISTICS

ITEM	SYMBO L	CONDITION	MIN.	TYP.	MAX.	UNIT	NOT E
Contrast ratio	K	φ=0	1.4	4	-	-	1
Response time (rise)	Tr	φ=1	-	130	-	ms	2
Response time (fall)	Tf	φ=2		130	-	ms	2
Viewing angle	φ	K ≥1.4	-40 +10				3
Viewing angle	θ	N ≥1.4	-3	-30 +30		deg.	J

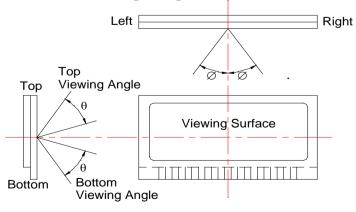
Note 1: Definition of Contrast Ratio "K"



Note 2: Definition of Optical Response Time



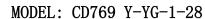
Note 3: Definition of Viewing Angle



Please select either top or bottom viewing angle

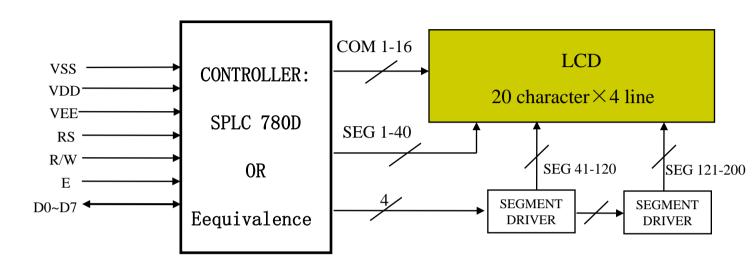
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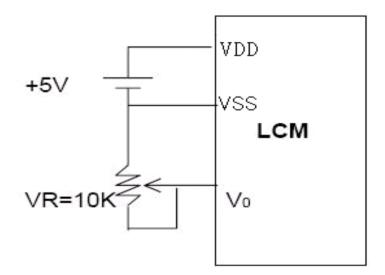




6. BLOCK DIAGRAM



7. POWER SUPPLY



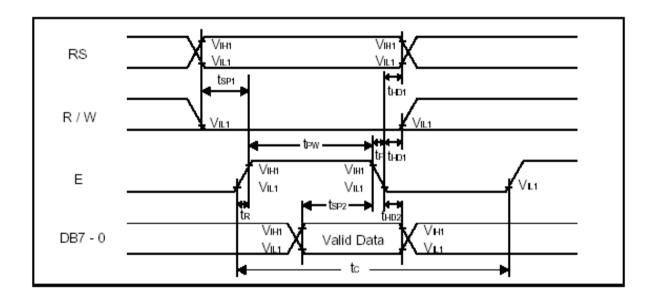
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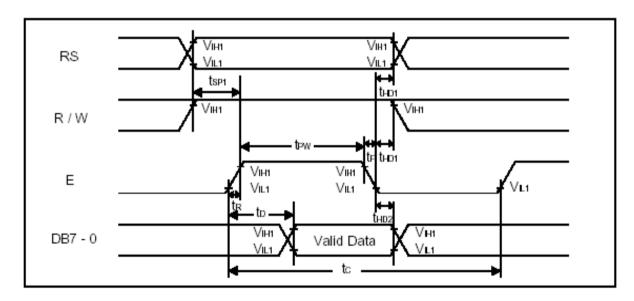


8. TIMING DIAGRAM

WRITE OPERATION



READ OPERATION



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9. AC CHARACTERISTICS

• WRITE MODE

			Limit				
Characteristics	Symbol	Min.	Тур. Мах.		Unit	Test Condition	
E Cycle Time	tc	1000	-	-	ns	Pin E	
E Pulse Width	tew	450	-	-	ns	Pin E	
E Rise/Fall Time	tr, tr	-	-	25	ns	Pin E	
Address Setup Time	tsp1	60	-	-	ns	Pins: RS, R/W, E	
Address Hold Time	tho1	20	-	-	ns	Pins: RS, R/W, E	
Data Setup Time	tsp2	195	-	-	ns	Pins: DB7 - 0	
Data Hold Time	t HD2	10	-	-	ns	Pins: DB7 - 0	

• READ MODE

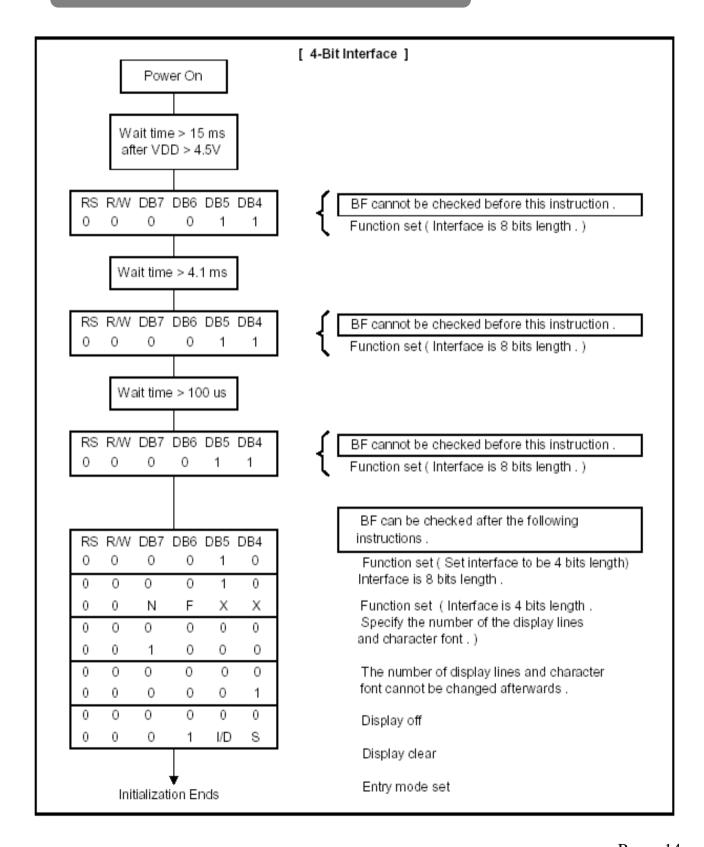
		Limit					
Characteristics	Symbol	Min.	Тур.	Max.	Unit	Test Condition	
E Cycle Time	tc	1000	1	-	ns	Pin E	
E Pulse Width	tw	450	1	-	ns	Pin E	
E Rise/Fall Time	tr, tr	ı	1	25	ns	Pin E	
Address Setup Time	tsp1	60	1	-	ns	Pins: RS, R/W,E	
Address Hold Time	t _{HD1}	20	1	-	ns	Pins: RS, R/W,E	
Data Output Delay Time	to	·	1	360	ns	Pins: DB7 - 0	
Data hold time	tHD2	5.0	-	-	ns	Pin DB7 - 0	

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10. INITIALIZATION SEQUENCE



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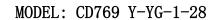


11. INSTRUCTION SET

COMMAND	COMMAND CODE									COMMAND CODE	E-CYCLE	
COMMAND	RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	COMMAND CODE	f _{osc} =250KHz
SCREEN CLEAR	0	0	0	0	0	0	0	0	0	1	Screen Clear, Set AC to 0 Cursor Reposition	1.64ms
CURSOR RETURN	0	0	0	0	0	0	0	0	1	*	DDRAM AD=0, Return, Content Changeless	1.64ms
INPUT SET	0	0	0	0	0	0	0	1	I/D	S	Set moving direction of cursor Appoint if move	40us
DISPLAY SWITCH	0	0	0	0	0	0	1	D	С	в	et display on/off,cursor on/off blink on/off	' 40us
SHIFT	0	0	0	0	0	1	S/C	R/L	*	*	Remove cursor and whole display,DDRAM changeless	40us
FUNCTION SET	0	0	0	0	1	DL	Ν	F	*	*	Set DL,display line,font	40us
CGRAM AD SET	0	0	0	1			AC	CG			Set CGRAM AD, send receive data	40us
DDRAM AD SET	0	0	1	ADD							Set DDRAM AD, send receive data	40us
BUSY/AD READ CT	0	1	BF	F AC							Executing internal function, reading AD of CT	40us
CGRAM/ DDRAM DATA WRITE	1	0			D.	ATA \	WRIT	Έ			Write data from CGRAM or DDRAM	40us
CGRAM/ DDRAM DATA READ	1	1	DATA READ								Read data from CGRAM or DDRAM	40us
	I/D=1: Increment Mode; I/D=0: Decrement Mode S=1: Shift S/C=1: Display Shift; S/C=0: Cursor Shift R/L=1: Right Shift; R/L=0: Left Shift DL=1: 8D DL=0: 4D N=1: 2R N=0: 1R F=1: 5x10 Style; F=0: 5x7 Style BF=1: Execute Internal Function; BF=0: Command Received								ACG: CGRAM AD ADD: DDRAM AD & Cursor	E-cycle changing with main frequency. Example: If fcp or fosc=270KHz 40us x 250/270 =37us		

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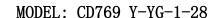


12. FONT TABLE

b7- b3 b4 -b0	0000	0010	0011	0100	0101	0110	0111	1010	1011	1100	1101	1110	1111
0000	CG/ RAM (1)			3	-		F= -			-3	= _		
0001	(2)	i	<u>i</u>	ii	Q	-=:	-:: <u>i</u>		_1-	;: -	i	-==	
0010	(3)	II				<u> </u>	;- -	T'	4	ij	,×*	 	
0011	(4)	#	.5		===	i	≝.	_i	",	;	==	==-	40-03
0100	(5)	#	#		Ī	==	† .	٠.		ŀ	•	 	:
0101	(6)	" :				:		==	-	:			
0110	(7)	8.	6	-	Ų	+"	Ų	=;	; ;		===	p	
0111	CG/ RAM (8)		7	<u> </u>	IJ.	==!	W	; ;;	#	;:: "		-	ΤĽ
1000	CG/ RAM /(1)	i.	8	i-i	×	! 1	×	-1	;	#.	Ļ	.,;-	$\overline{\times}$
1001	(2)	>	9	Į.	¥	j.	-==	:	-	<u>.</u> !	ıĿ	≣	-
1010	(3)	**	# #		2	i	3 2.			'n	<u> </u>		
1011	(4)		# #	K		k	{	7	#			* "	F
1100	(5)	3	<_	<u></u>	#	1		1:	= .:	<u>"</u>	ŗŢ	4	
1101	(6)	••••	===	M]	m	}		: <u>.</u>	^,	<u></u> ;	#_	
1110	(7)	==	>	ŀŀ	•	l'"i	-3-	==	13	:†:	•••	F	
1111	CG/ RAM/(8)		- :-			i <u></u> i	 -	111	'. !	-:		Ö	

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13. QUALITY ASSURANCE

13.1.1 Temperature and Humidity(Ambient Temperature)

Temperature : $20 \pm 5^{\circ}$ C Humidity : $65 \pm 5\%$

131.1.2 Operation

Unless specified otherwise, test will be conducted under function state.

13.1.3 Container

Unless specified otherwise, vibration test will be conducted to the product itself without putting it in a container.

13.1.4 Test Frequency

In case of related to deterioration such as shock test. It will be conducted only once.

13.1.5 Test Method

No.	Parameter	Conditions	Regulations
1	High Temperature Operating	70±2℃	Note 3
2	Low Temperature Operating	-20 ±2℃	Note 3
3	High Temperature Storage	80±2℃	Note 3
4	Low Temperature Storage	-30±2℃	Note 3
5	Vibration Test (Non-operation state)	Total fixed amplitude: 1.5mm Vibration Frequency: 10 ~ 55Hz One cycle 60 seconds to 3 directions of X.Y.Z. for each 15 minutes	Note 3
6	Damp Proof Test (Non-operation state)	40°C±2°C,90~95%RH,96h	Note 1,2
7	Shock Test (Non-operation state)	To be measured after dropping from 60cm high once concrete surface in packing state	Note 3

Note 1: Returned under normal temperature and humidity for 4 hrs.

Note 2: No dew condensation to be observed.

Note 3: No change on display and in operation under the test condition

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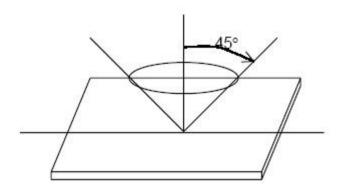
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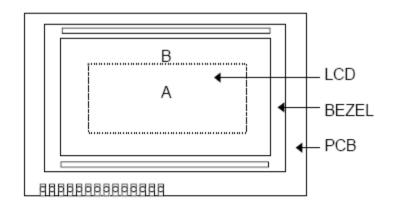
13.2Inspection condition

13.2.1 Inspection conditions

The LCD shall be inspected under 40W white fluorescent light.



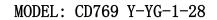
13.2.2 Definition of applicable Zones



A : Display Area B : Non-Display Area

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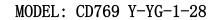


13.2.3 Inspection Parameters

No.	Parameter	Criteria
1	Black or White spots	
2	Scratch, Substances	$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$
3	Air Bubbles (between glass & polarizer)	
4	Uniformity of Pixel	(1) Pixel shape (with Dent) 0.152

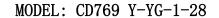
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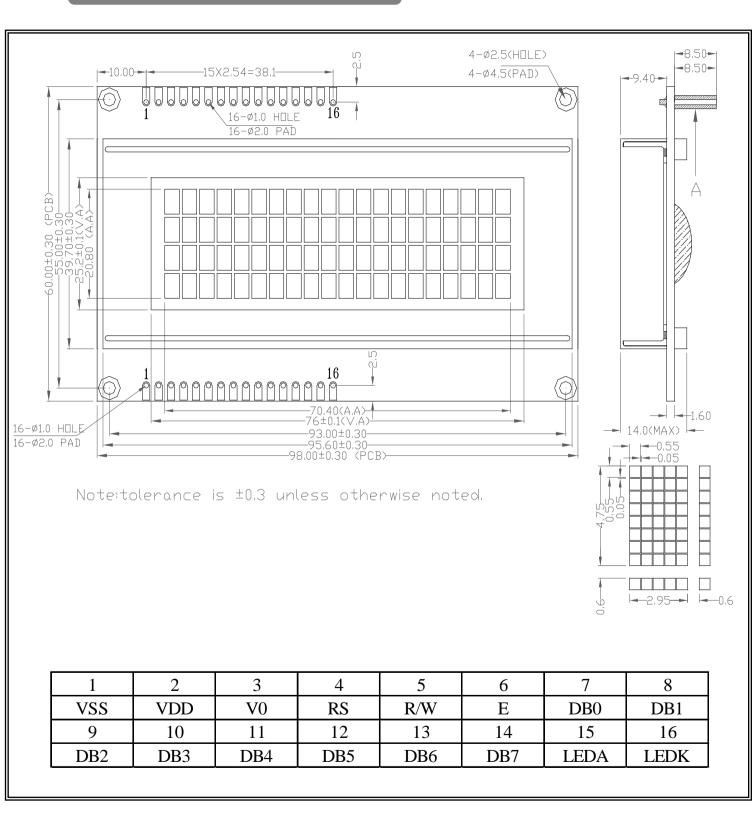


			(2) Pixel shape (with Projection)						
			Should not be connected to next pixel 0.152						
			(3) Pin hole						
4	Uniformity of Pixel		Uniformity of Pixel		Uniformity of Pixel		Uniformity of Pixel		X Y (X + Y)/2 ≤ 0.02mm (Less than 0.1 mm is no counted)
			(4) Deformation						
			X (X+Y)/2≤0.3mm Y Total acceptable number : 1/pixel, 5/cell						
			Definition						
Class of	Major	AQL 0.65%	It is a defect that is likely to result in failure or to reduce materially the usability of the product for the intended function.						
defects		AQL 1.00%	It is a defect that is likely to assembly size and not						
,	Minor AQL 2.5%		result in functioning problem. It is a defect that will not result in functioning problem with deviation classified.						



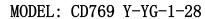


14. OUTLINE DRAWING



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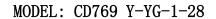


15. INTERFACE

PIN NO.	SYMBOL	DESCRIPTION	FUNCTION		
1	VSS	GROUND	0V (GND)		
2	VDD	POWER SUPPLY FOR LOGIC	+5V		
Δ	עטע	CIRCUIT	+3 V		
3	V0	LCD CONTRAST			
	VO	ADJUSTMENT			
4	RS	INSTRUCTION/DATA	RS = 0: INSTRUCTION REGISTER		
	No	REGISTER SELECTION	RS = 1 : DATA REGISTER		
5	R/W	READ/WRITE SELECTION	R/W = 0: REGISTER WRITE		
3	IV VV	READ/WRITE SELECTION	R/W = 1 : REGISTER READ		
6	Е	ENABLE SIGNAL			
7	DB0				
8	DB1				
9	DB2				
10	DB3	DATA BUS	8 BIT: DB0-DB7		
11	DB4	DATABUS	6 BH. DBU-DB/		
12	DB5				
13	DB6				
14	DB7				
15	LEDA	SUPPLY VOLTAGE FOR	+4.2V		
13		LED+			
16	LEDK	SUPPLY VOLTAGE FOR LED-	0V		

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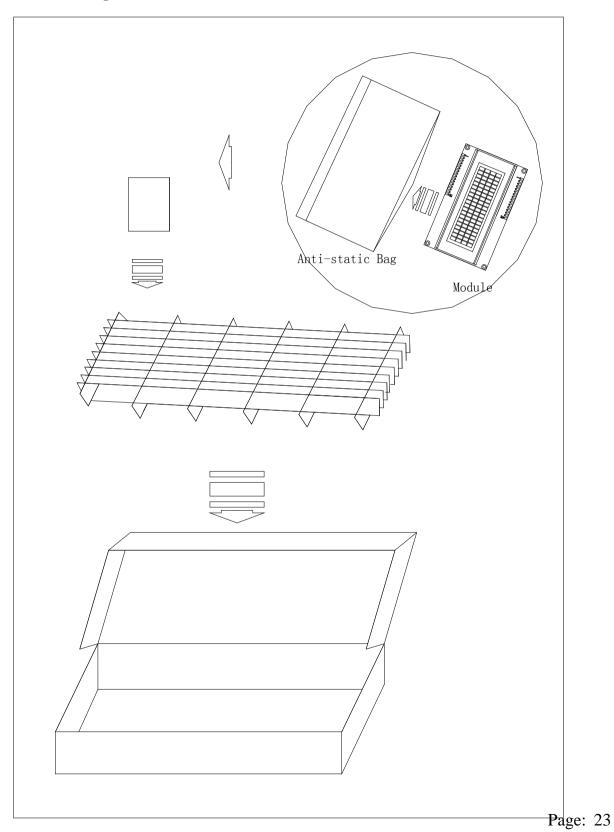
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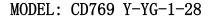


16. PACKAGE INFORMATION

A Box include 50pcs

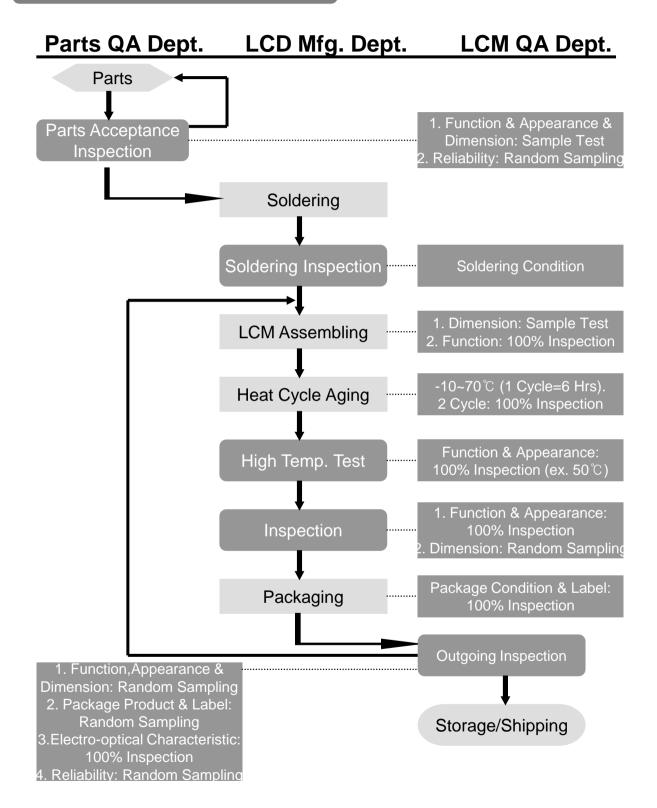


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17. QC/QA PROCEDURE



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8. Handling Precautions

1. Limitation of Application:

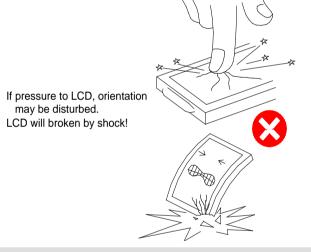
Optrex products are designed for use in ordinary electronic devices such as business machines, telecommunications equipment, measurement devices and etc. Please handle the products with care. (see below)

Optrex products are not designed, intended ,or authorized for use in any application which the failure of the product could result in a situation where personal injury or death may occur, these applications include, but are not limited to. life-sustaining equipment, nuclear control devices, aerospace equipment, devices related to hazardous or flammable materials, etc.[If Buyer intends to purchase or use the Optrex Products for such unintended or unauthorized applications, Buyer must secure prior written consent to such use by a responsible officer of Optrex Corporation.] Should Buyer purchase or use Optrex Products for any such unintended or unauthorized application [without such consent]. Buyer shall indemnify and hold Optrex and its officers. employees, subsidiaries, affiliates and distributors harmless against all claims, costs, damages and expenses, and reasonable attorney's fees, arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that Optrex was negligent regarding the design or manufacture of the part. 2. Industrial Rights and Patents

Optrex shall not be responsible for any infringement of industrial property rights of third parties in any country arising out of the application or use of Optrex products, except which directly concern the structure or production of such products.

No Press and Shock!

Don't Swallow or Touch Liquid Crystal!

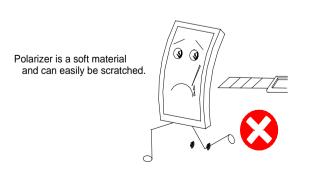


Liquid Crystal may be leaked when display is broked. If it accidentally gets your hands, wash then with water!



Don't not Scratch!

No DC Voltage to LCD!

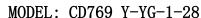


DC volrage or driveing higher than the specified voltage will reduce the lifetime of



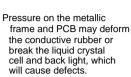
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Don't Press the Metallic Frame and Disassemble Slowly Peel Off Protective Film! the LCM



LCD may be shifted or conductive rubber may be reshaped, which will cause defects.

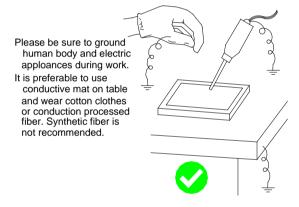


Avoid static electricity.



Avoid Static Electricity!

Wear Gloves While Handing!



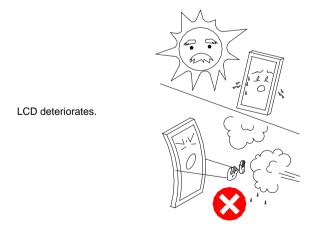
It is preferable to wear gloves to avoid damaging the LCD.

Please do not touch electrodes with bare hands or make them dirty.

GLOVE

Keep Away From Extreme Heat and Humidity!

Use Alcohol to Clean Terminals!



When attaching with the heat seal or anisontropically conductive film, wipe off with alcohol before use.

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Don't Drop Water on LCD!

Note that the presence of waterdrops or dew in the LCD panel may deteriorate the polarizer or corrade electrode.



Precaution in Soldering LCD Module

Basic instructions: Solder I/O terminals only.

Use soldering iron without leakage.

(1) Soldering condition to I/O terminals

Temperature at tip of the iron: $280 \pm 10^{\circ}$

Soldering time: 3~4 sec.

Type of solder: Eutectic solder (containing colophony-flux)

- *Please do not use flux because it may soak into LCD Module or contaminate it.
- *It is preferable to peel off protective film on display surface after soldering I/O terminals is finished.
- (2)Remove connector or cable
 - *When you remove connector or cable soldered to I/O terminals, please confirm that solder is fully melted. If you remove by force, electrodes at I/O terminals may be damaged(or stripped off).
 - *It is recommended to use solder suction machine.

Long-term Storage

If it is necessary to store LCD modules for a long time, please comply with the following procedures.

If storage condition is not satisfactory, display(especially polarizer) may be deteriorated or soldering I/O terminals may become difficult(some oxide is generated at I/O terminals plating).

- 1.Store as delivered by Optrex
- 2.If you store as unpacked,put in anti-static bag,seal its opening and store where it is not subjected to direct sunshine nor fluorescent lamp.
- 3.Store at temperature 0 to +35 °C and at low humidity. Please refer to our specification sheets for storage temperature range and humidity condition.

Long-term Storage

Please use power supply with built-in surge protection circuit.

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